ALPHA & OMEGA SEMICONDUCTOR

AO3495

20V P-Channel MOSFET

General Description

- Low $R_{DS(ON)}$
- RoHS and Halogen-Free Compliant

Applications

- Load switch
- PWM

Product Summary

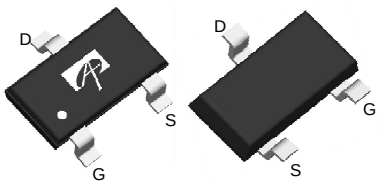
V_{DS}	-20V
I_D (at V_{GS}=-4.5V)	-5A
$R_{DS(ON)}$ (at V_{GS}= -4.5V)	< 41mΩ
$R_{DS(ON)}$ (at V_{GS}= -2.5V)	< 53mΩ
$R_{DS(ON)}$ (at V_{GS}= -1.8V)	< 65mΩ

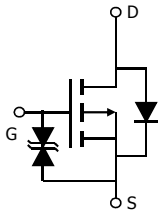
ESD protected

Green Product

SOT23

Top View Bottom View





Absolute Maximum Ratings T_A=25°C unless otherwise noted

Parameter		Symbol	Maximum	Units
Drain-Source Voltage		V_{DS}	-20	V
Gate-Source Voltage		V_{GS}	±8	V
Continuous Drain Current	T_A=25°C	I_D	-5	A
	T_A=70°C		-4	
Pulsed Drain Current [C]		I_{DM}	-30	
Power Dissipation [B]	T_A=25°C	P_D	1.5	W
	T_A=70°C		1	
Junction and Storage Temperature Range		T_J, T_{STG}	-55 to 150	°C

Thermal Characteristics

Parameter		Symbol	Typ	Max	Units
Maximum Junction-to-Ambient [A]	t ≤ 10s	$R_{\theta JA}$	65	80	°C/W
Maximum Junction-to-Ambient [A D]	Steady-State		85	100	°C/W
Maximum Junction-to-Lead	Steady-State	$R_{\theta JL}$	43	52	°C/W

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Electrical Characteristics (T_J=25°C unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
STATIC PARAMETERS						
BV_{DSS}	Drain-Source Breakdown Voltage	I_D=-250µA, V_{GS}=0V	-20			V
I_{DSS}	Zero Gate Voltage Drain Current	V_{DS}=-20V, V_{GS}=0V			-1	µA
		T_J=55°C			-5	
I_{GSS}	Gate-Body leakage current	V_{DS}=0V, V_{GS}= ±8V			±10	µA
$V_{GS(th)}$	Gate Threshold Voltage	V_{DS}=V_{GS}, I_D=-250µA	-0.3	-0.57	-0.9	V
$I_{D(ON)}$	On state drain current	V_{GS}=-4.5V, V_{DS}=-5V	-30			A
$R_{DS(ON)}$	Static Drain-Source On-Resistance	V_{GS}=-4.5V, I_D=-4A		34	41	mΩ
		T_J=125°C		49	59	
		V_{GS}=-2.5V, I_D=-4A		42	53	mΩ
		V_{GS}=-1.8V, I_D=-2A		52	65	mΩ
		V_{GS}=-1.5V, I_D=-1A		61		mΩ
g_{FS}	Forward Transconductance	V_{DS}=-5V, I_D=-4A		20		S
V_{SD}	Diode Forward Voltage	I_S=-1A,V_{GS}=0V		-0.64	-1	V
I_S	Maximum Body-Diode Continuous Current				-2	A
DYNAMIC PARAMETERS						
C_{iss}	Input Capacitance	V_{GS}=0V, V_{DS}=-10V, f=1MHz		751		pF
C_{oss}	Output Capacitance			115		pF
C_{rss}	Reverse Transfer Capacitance			80		pF
R_g	Gate resistance	V_{GS}=0V, V_{DS}=0V, f=1MHz	6	13	20	Ω
SWITCHING PARAMETERS						
Q_g	Total Gate Charge	V_{GS}=-4.5V, V_{DS}=-10V, I_D=-4A		9.3	20	nC
Q_{gs}	Gate Source Charge			1		nC
Q_{gd}	Gate Drain Charge			2.2		nC
$t_{D(on)}$	Turn-On DelayTime	V_{GS}=-4.5V, V_{DS}=-10V, R_L=2.5Ω, R_{GEN}=3Ω		13		ns
t_r	Turn-On Rise Time			9		ns
$t_{D(off)}$	Turn-Off DelayTime			19		ns
t_f	Turn-Off Fall Time			29		ns
t_{rr}	Body Diode Reverse Recovery Time	I_F=-4A, dI/dt=500A/µs		26		ns
Q_{rr}	Body Diode Reverse Recovery Charge	I_F=-4A, dI/dt=500A/µs		51		nC

A. The value of $R_{\theta JA}$ is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with T_A =25° C. The value in any given application depends on the user's specific board design.
B. The power dissipation P_D is based on $T_{J(MAX)}$=150° C, using ≤ 10s junction-to-ambient thermal resistance.
C. Repetitive rating, pulse width limited by junction temperature $T_{J(MAX)}$=150° C. Ratings are based on low frequency and duty cycles to keep initialT_J=25° C.
D. The $R_{\theta JA}$ is the sum of the thermal impedance from junction to lead $R_{\theta JL}$ and lead to ambient.
E. The static characteristics in Figures 1 to 6 are obtained using <300µs pulses, duty cycle 0.5% max.
F. These curves are based on the junction-to-ambient thermal impedance which is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, assuming a maximum junction temperature of $T_{J(MAX)}$=150° C. The SOA curve provides a single pulse rating.

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TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

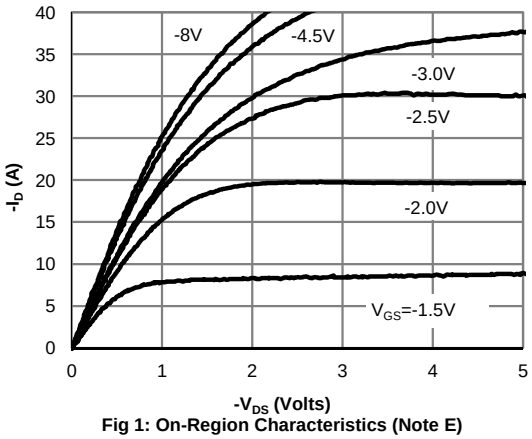

Fig 1: On-Region Characteristics (Note E)

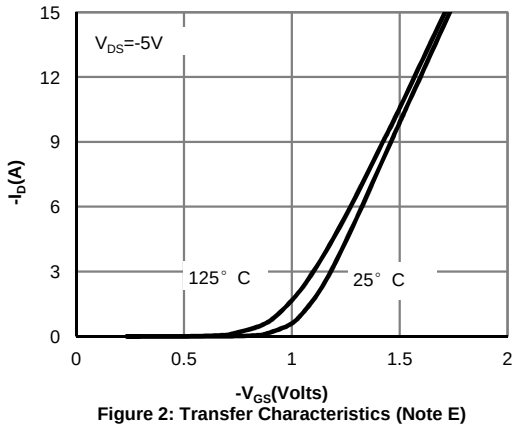

Figure 2: Transfer Characteristics (Note E)

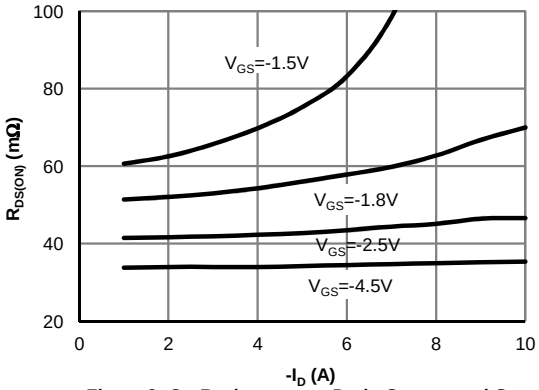

Figure 3: On-Resistance vs. Drain Current and Gate Voltage (Note E)

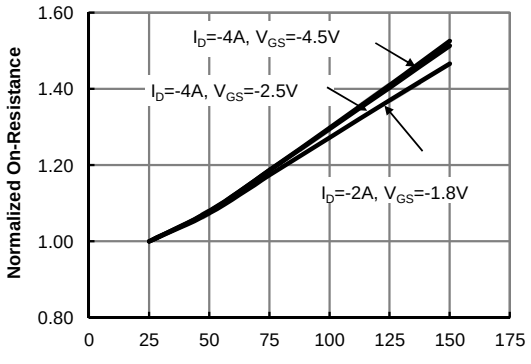

Figure 4: On-Resistance vs. Junction Temperature (Note E)

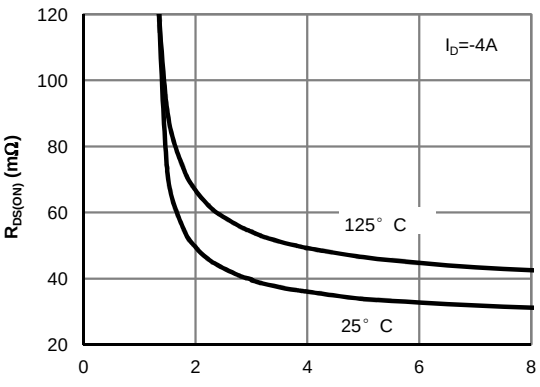

Figure 5: On-Resistance vs. Gate-Source Voltage (Note E)

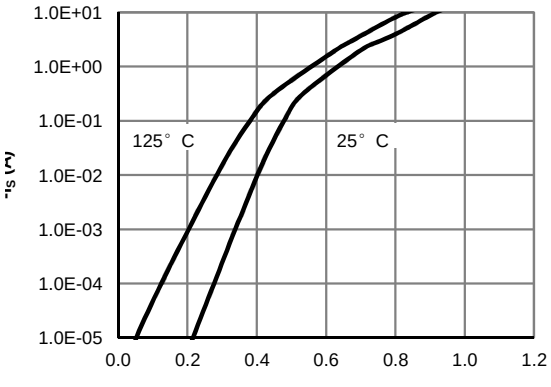

Figure 6: Body-Diode Characteristics (Note E)

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TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

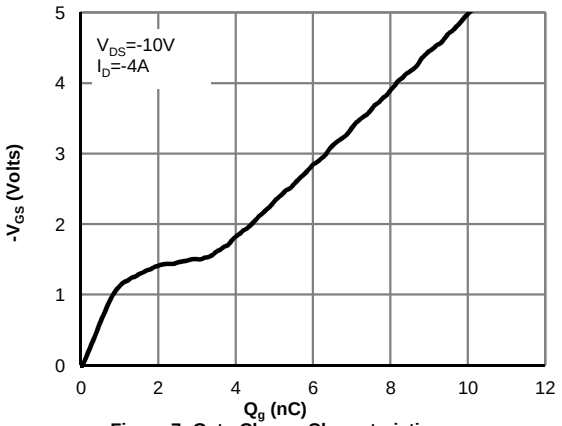

Figure 7: Gate-Charge Characteristics

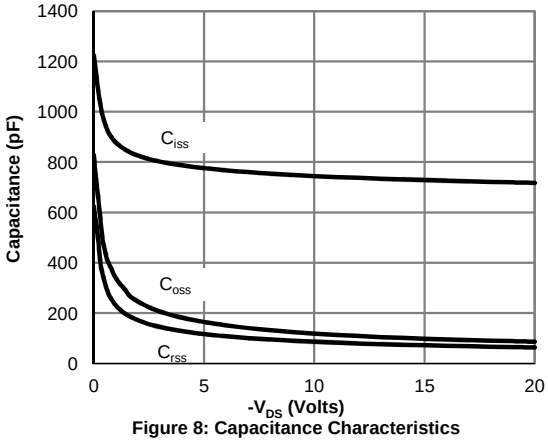

Figure 8: Capacitance Characteristics

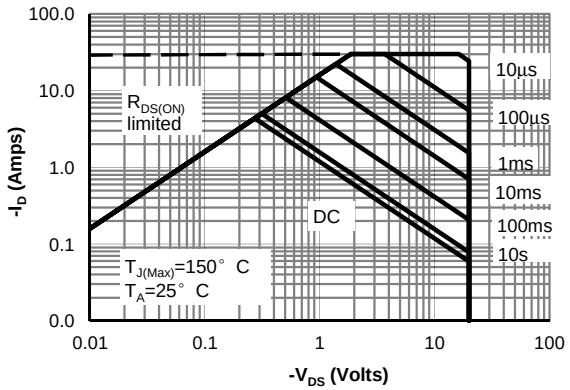

Figure 9: Maximum Forward Biased Safe Operating Area (Note F)

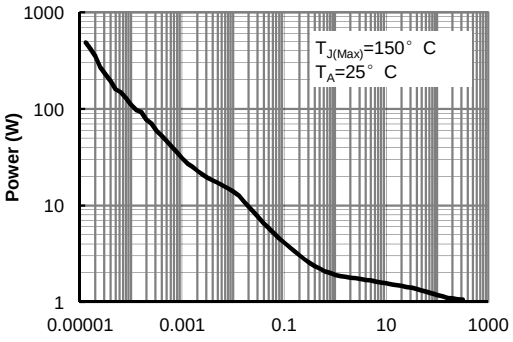

Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note F)

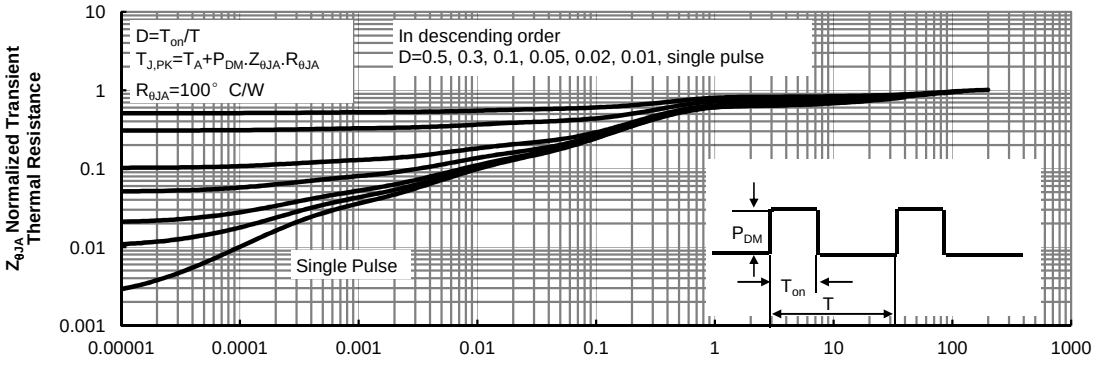

Figure 11: Normalized Maximum Transient Thermal Impedance (Note F)

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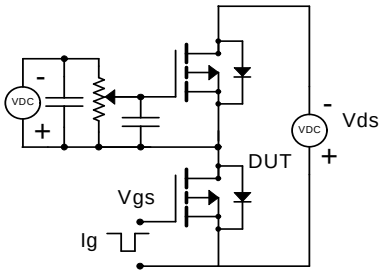
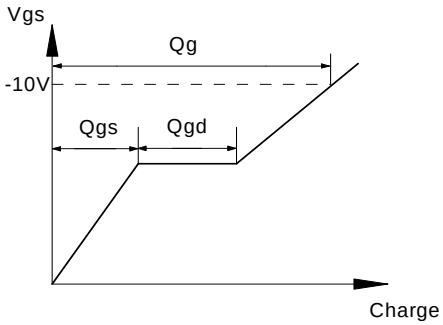
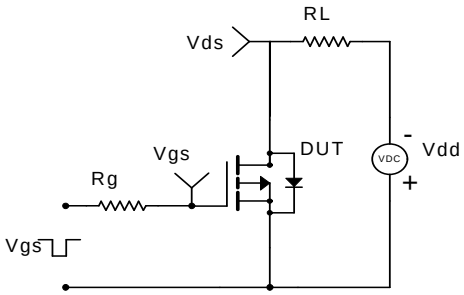
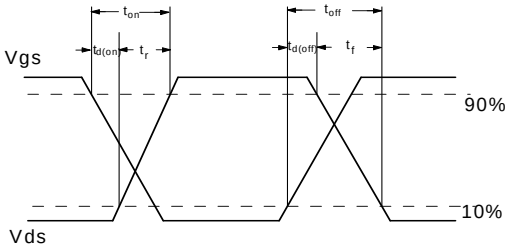
Gate Charge Test Circuit & Waveform



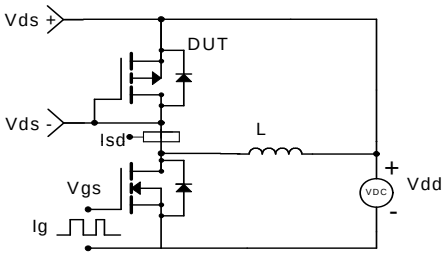


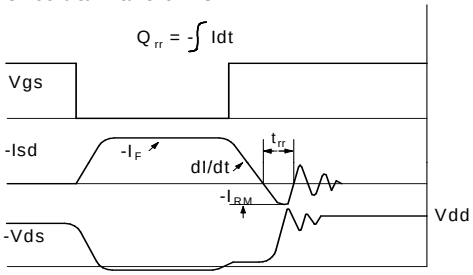
Resistive Switching Test Circuit & Waveforms





Diode Recovery Test Circuit & Waveforms





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